

## N-channel PowerMESH™ 600 V, 14 A very fast IGBT

Datasheet - obsolete product

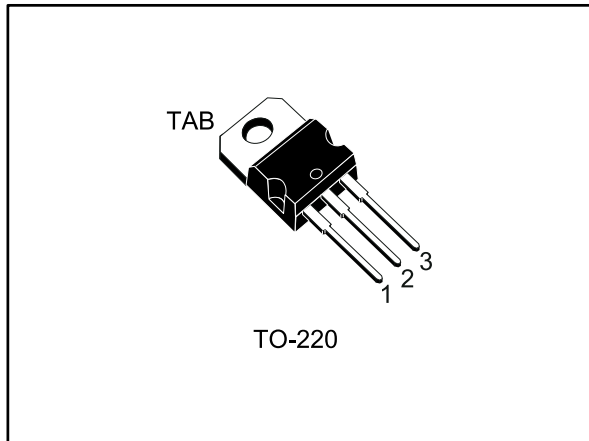
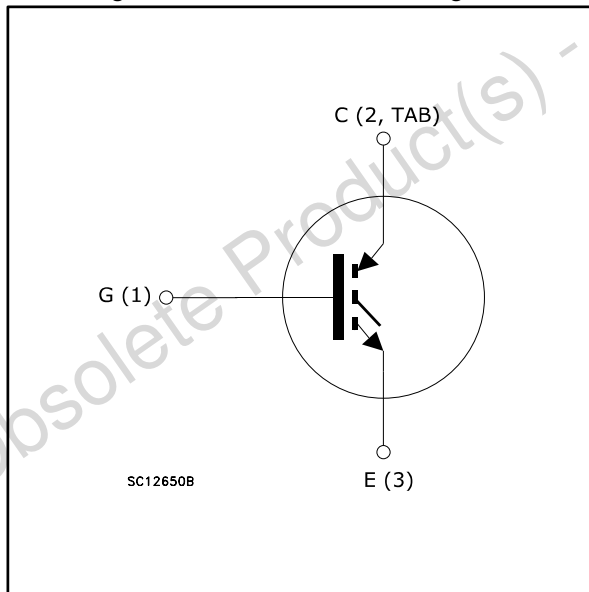


Figure 1: Internal schematic diagram



### Features

Order code	V <sub>CES</sub>	V <sub>CE(sat)</sub> max @ 25°C	I <sub>c</sub> @ 100°C
STGP7NC60H	600 V	< 2.5 V	14 A

- Low on-voltage drop (V<sub>CE(sat)</sub>)
- High frequency operation up to 70 kHz

### Applications

- High frequency inverters
- SMPS and PFC in both hard switch and resonant topologies
- Motor drivers

### Description

This device is a very fast IGBT developed using advanced PowerMESH™ technology. This process guarantees an excellent trade-off between switching performance and low on-state behavior. This device is well-suited for resonant or soft-switching applications.

Table 1: Device summary

Order code	Marking	Package	Packing
STGP7NC60H	GP7NC60H	TO-220	Tube

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**Contents**

<b>1</b>	<b>Electrical ratings</b> .....	<b>3</b>
<b>2</b>	<b>Electrical characteristics</b> .....	<b>4</b>
	2.1 Electrical characteristics (curves).....	6
<b>3</b>	<b>Test circuits</b> .....	<b>9</b>
<b>4</b>	<b>Package information</b> .....	<b>10</b>
	4.1 TO-220 type A package information.....	11
<b>5</b>	<b>Revision history</b> .....	<b>13</b>

Obsolete Product(s) - Obsolete Product(s)

# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GE</sub> = 0)	600	V
V <sub>GE</sub>	Gate-emitter voltage	±20	V
I <sub>C</sub>	Continuous collector current at T <sub>C</sub> = 25 °C <sup>(1)</sup>	25	A
	Continuous collector current at T <sub>C</sub> = 100 °C <sup>(1)</sup>	14	A
I <sub>CM</sub> <sup>(2)</sup>	Collector current (pulsed)	50	A
P <sub>TOT</sub>	Continuous forward current at T <sub>C</sub> = 25 °C	80	W
T <sub>stg</sub>	Storage temperature range	- 55 to 150	°C
T <sub>J</sub>	Operating junction temperature range		

**Notes:**

<sup>(1)</sup>Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{JMAX} - T_C}{R_{THJ-C} \times V_{CESAT(MAX)}(T_{J(max)}) \times I_C(T_C)}$$

<sup>(2)</sup>Pulse width limited by maximum junction temperature.

**Table 3: Thermal data**

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.56	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	62.5	°C/W

## 2 Electrical characteristics

$T_C = 25\text{ °C}$  unless otherwise specified

**Table 4: Static characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE} = 0\text{ V}$ , $I_C = 1\text{ mA}$	600			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}$ , $I_C = 7\text{ A}$		1.85	2.5	V
		$V_{GE} = 15\text{ V}$ , $I_C = 7\text{ A}$ , $T_J = 125\text{ °C}$		1.7		
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}$ , $I_C = 250\text{ }\mu\text{A}$	3.75		5.75	V
$I_{CES}$	Collector cut-off current	$V_{GE} = 0\text{ V}$ , $V_{CE} = 600\text{ V}$			10	$\mu\text{A}$
		$V_{GE} = 0\text{ V}$ , $V_{CE} = 600\text{ V}$ , $T_C = 125\text{ °C}$ <sup>(1)</sup>			1	mA
$I_{GES}$	Gate-emitter leakage current	$V_{CE} = 0\text{ V}$ , $V_{GE} = \pm 20\text{ V}$			$\pm 100$	nA

**Notes:**

<sup>(1)</sup>Defined by design, not subject to production test.

**Table 5: Dynamic characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$g_{fs}$ <sup>(1)</sup>	Forward transconductance	$V_{CE} = 15\text{ V}$ , $I_C = 7\text{ A}$		4.30		S
$C_{ies}$	Input capacitance	$V_{CE} = 25\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GE} = 0\text{ V}$		720		pF
$C_{oes}$	Output capacitance			81		pF
$C_{res}$	Reverse transfer capacitance			17		pF
$Q_g$	Total gate charge		$V_{CE} = 390\text{ V}$ , $I_C = 7\text{ A}$ , $V_{GE} = 15\text{ V}$ (see <a href="#">Figure 18: "Gate charge test circuit"</a> )		35	48
$Q_{ge}$	Gate-emitter charge			7		
$Q_{gc}$	Gate-collector charge			16		
$I_{CL}$	Turn-off SOA minimum current	$V_{clamp} = 480\text{ V}$ , $T_J = 150\text{ °C}$ , $R_G = 10\text{ }\Omega$ , $V_{GE} = 15\text{ V}$	50			A

**Notes:**

<sup>(1)</sup>Pulsed: Pulse duration= 300  $\mu\text{s}$ , duty cycle 1.5%

Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 390\text{ V}$ , $I_C = 7\text{ A}$ , $V_{GE} = 15\text{ V}$ , $R_G = 10\ \Omega$ (see <i>Figure 16: "Ic vs frequency"</i> and <i>Figure 17: "Test circuit for inductive load switching"</i> )	-	18.5		ns
$t_{r(on)}$	Turn-on rise time		-	8.5		ns
$di/dt_{(on)}$	Turn-on current slope		-	1060		A/ $\mu$ s
$t_{r(off)}$	Turn-off rise time		-	27		ns
$t_{d(off)}$	Turn-off delay time		-	72		ns
$t_f$	Fall time		-	60		ns
$E_{on}^{(1)}$	Turn-on switching energy		-	95	125	$\mu$ J
$E_{off}^{(2)}$	Turn-off switching energy		-	115	150	$\mu$ J
$E_{ts}$	Total switching energy		-	210	275	$\mu$ J
$t_{d(on)}$	Turn-on delay time		$V_{CE} = 390\text{ V}$ , $I_C = 7\text{ A}$ , $V_{GE} = 15\text{ V}$ , $R_G = 10\ \Omega$ $T_J = 125\text{ }^\circ\text{C}$ (see <i>Figure 17: "Test circuit for inductive load switching"</i> )	-	18.5	
$t_{r(on)}$	Turn-on rise time	-		7		ns
$di/dt_{(on)}$	Turn-on current slope	-		1000		A/ $\mu$ s
$t_{r(off)}$	Turn-off rise time	-		56		ns
$t_{d(off)}$	Turn-off delay time	-		116		ns
$t_f$	Fall time	-		105		ns
$E_{on}^{(1)}$	Turn-on switching energy	-		140		$\mu$ J
$E_{off}^{(2)}$	Turn-off switching energy	-		215		$\mu$ J
$E_{ts}$	Total switching energy	-		355		$\mu$ J

**Notes:**<sup>(1)</sup>Including the reverse recovery of the diode.<sup>(2)</sup>Including the tail of the collector current.

2.2 Electrical characteristics (curves)

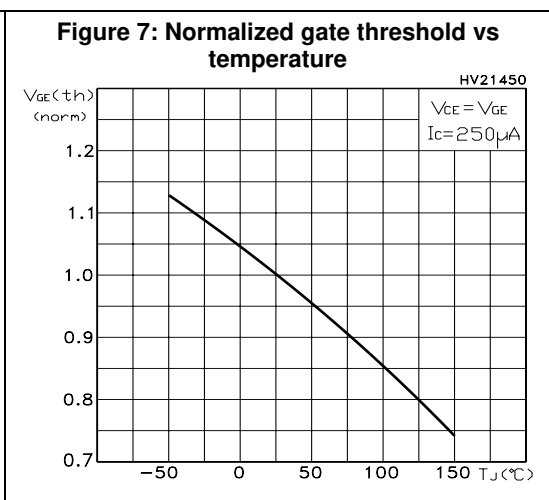
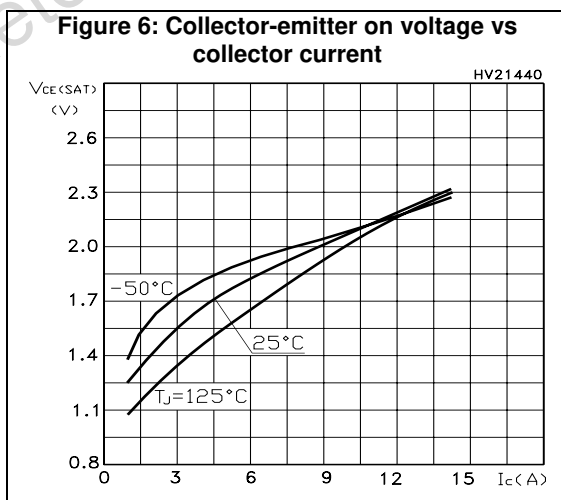
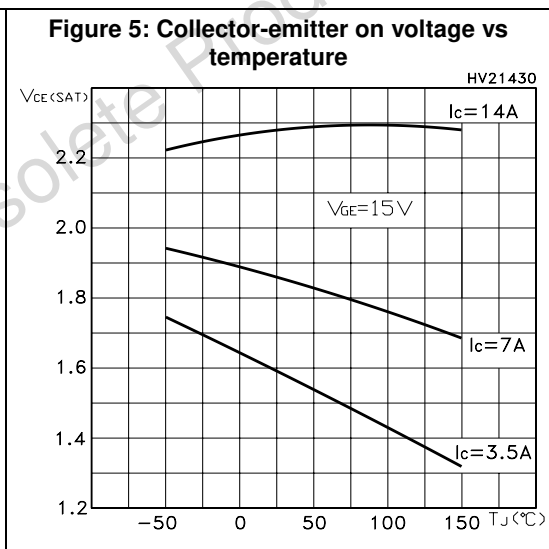
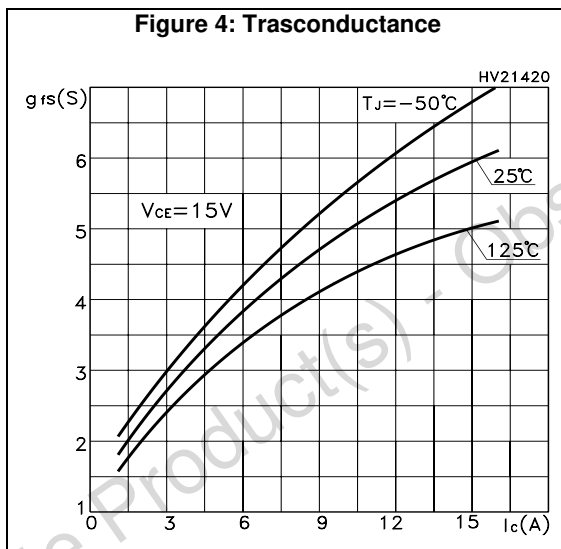
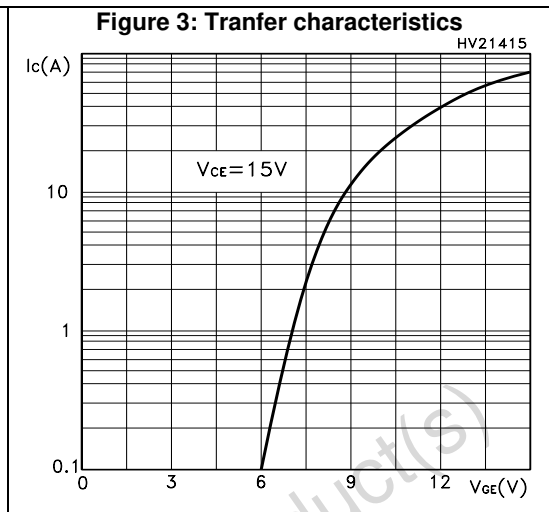
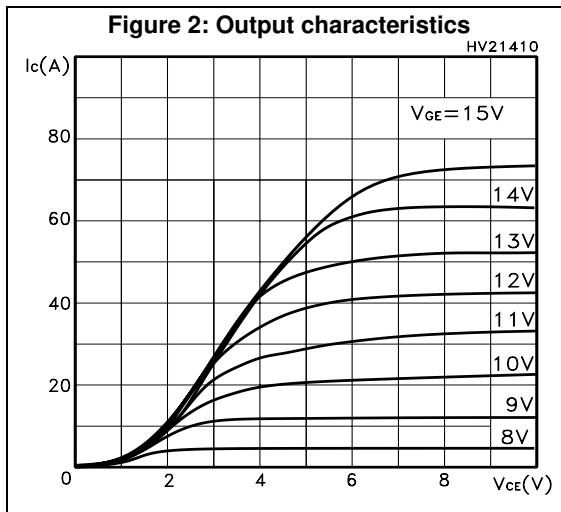


Figure 8: Normalized breakdown voltage vs temperature

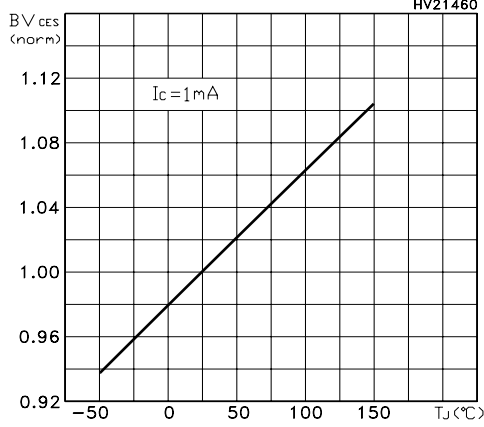


Figure 9: Gate charge vs gate-emitter voltage

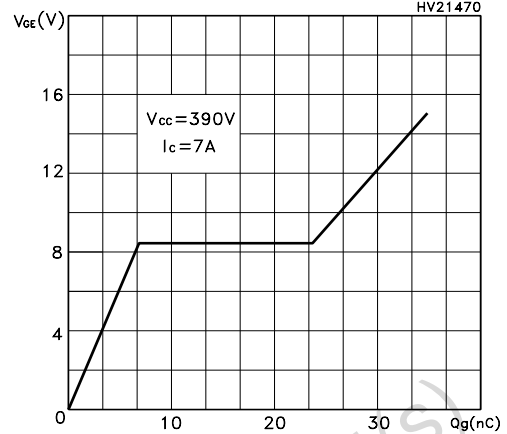


Figure 10: Capacitance variations

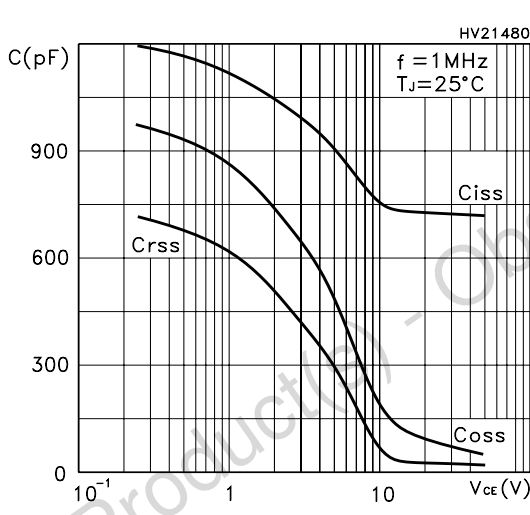


Figure 11: Total switching energy vs temperature

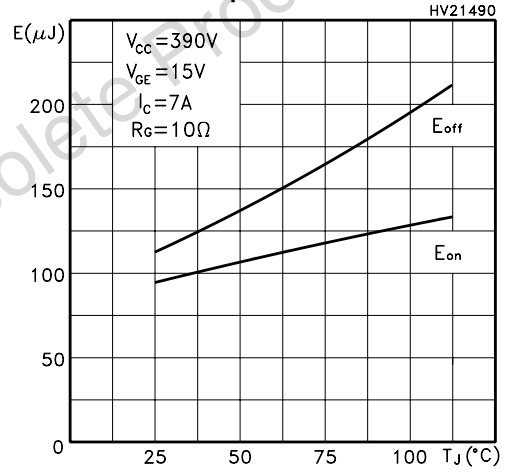


Figure 12: Total switching energy vs gate resistance

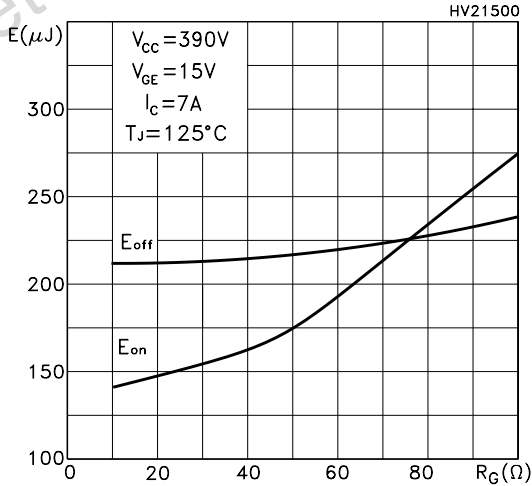
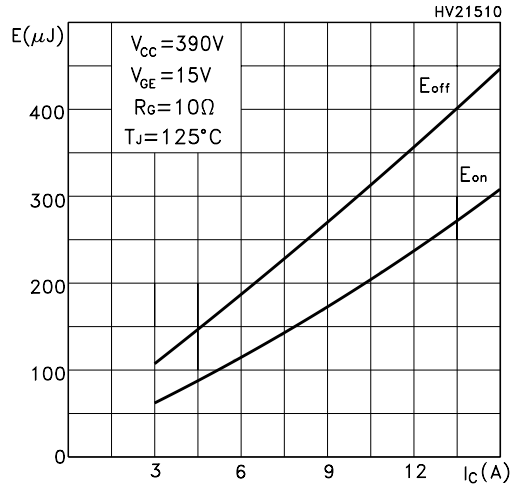
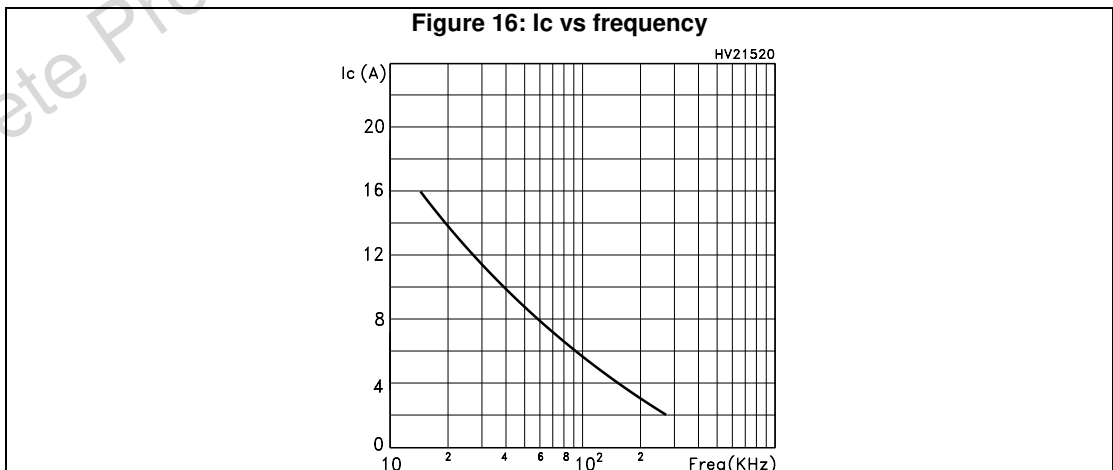
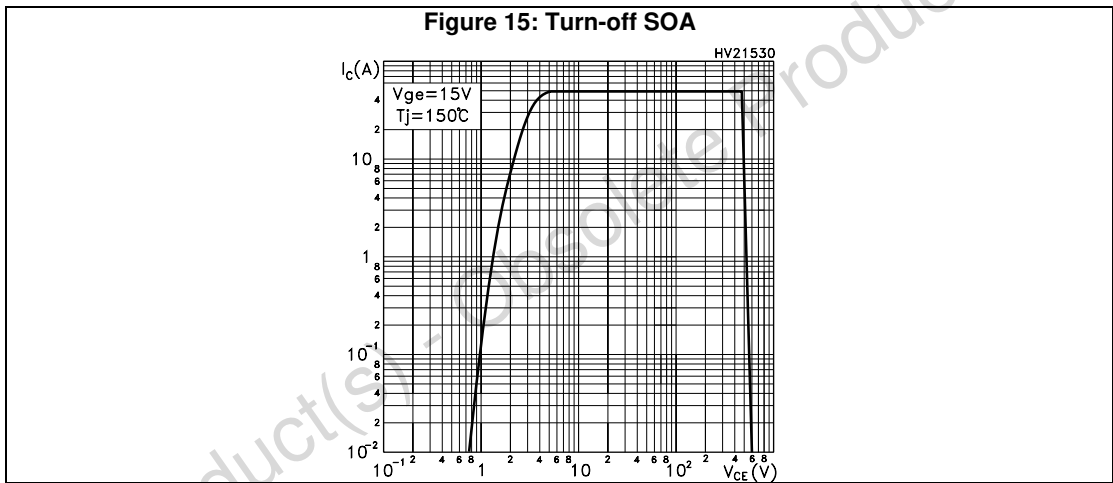
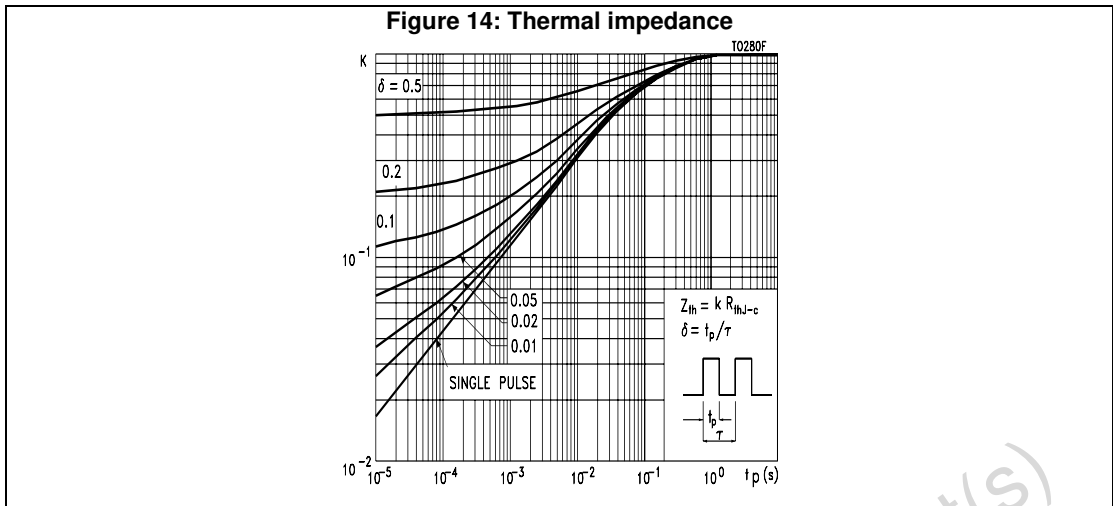


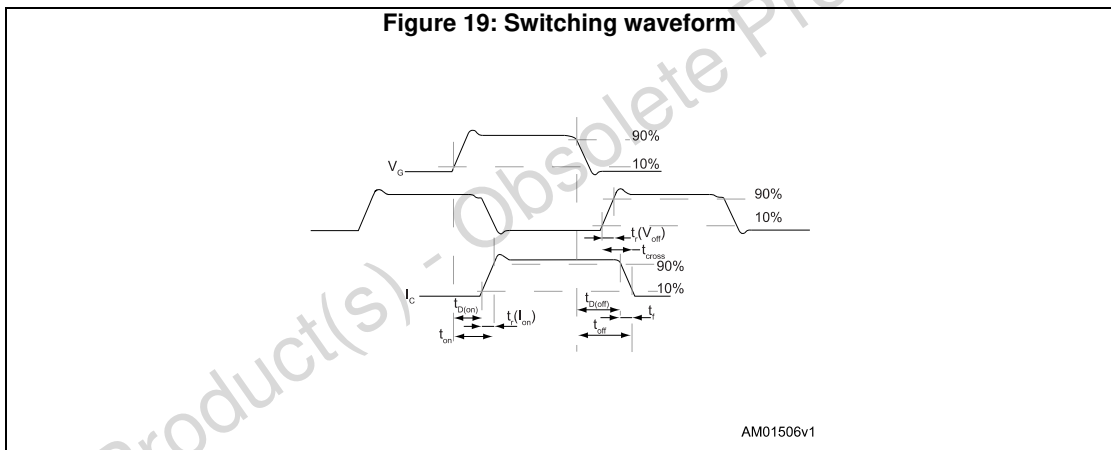
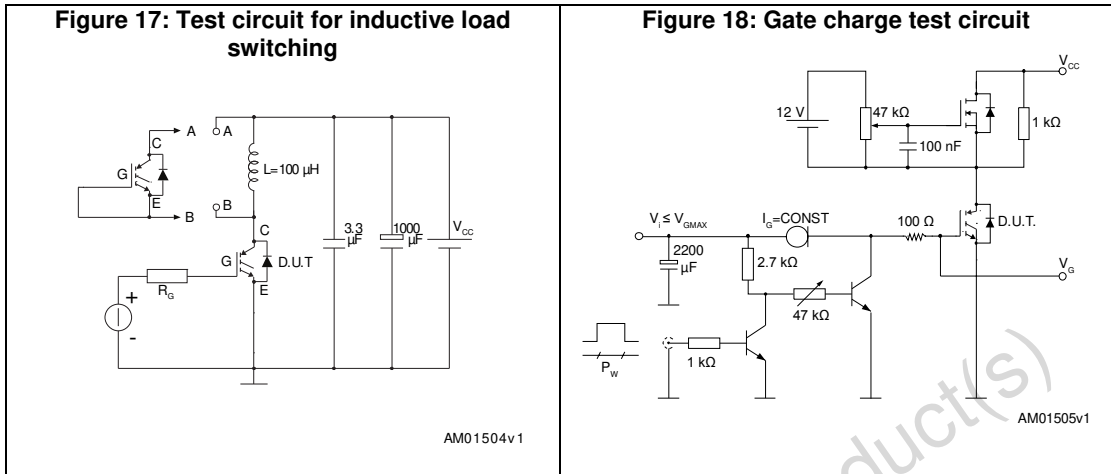
Figure 13: Total switching energy vs collector current







### 3 Test circuits



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

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### 4.1 TO-220 type A package information

Figure 20: TO-220 type A package outline

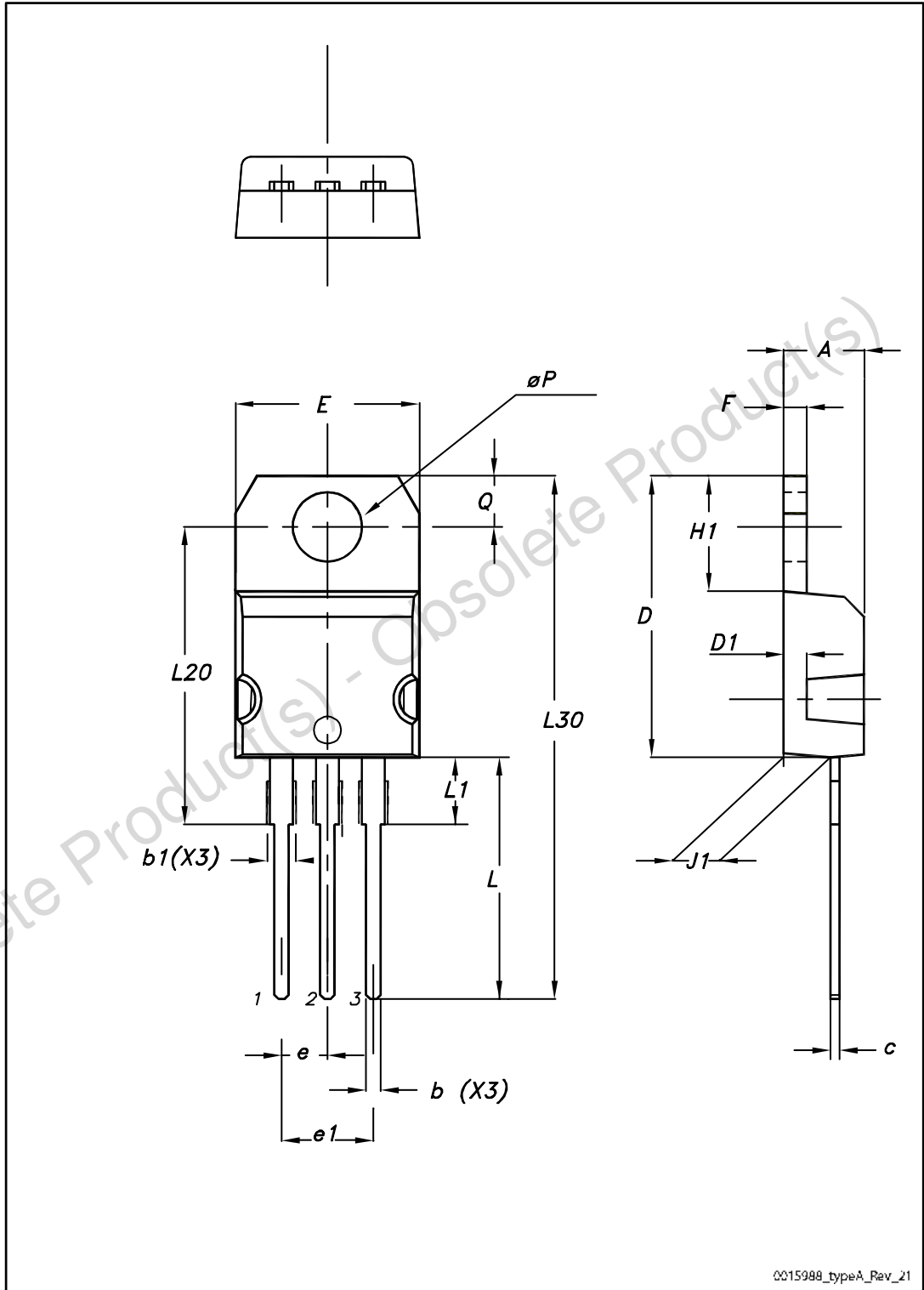


Table 7: TO-220 type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

## 5 Revision history

**Table 8: Document revision history**

Date	Revision	Changes
20-Aug-2004	1	New datasheet.
09-Jun-2005	2	Modified title
04-Jul-2016	3	<p>The part number STGD7NC60HT4 has been moved to a separate datasheet.</p> <p>Modified: title, features and description.</p> <p>Modified: <i>Table 2: "Absolute maximum ratings"</i>, <i>Table 3: "Thermal data"</i>, <i>Table 4: "Static characteristics"</i>, <i>Table 5: "Dynamic characteristics (inductive load)"</i> and <i>Table 6: "IGBT switching characteristics (inductive load)"</i></p> <p>Updated: <i>Section 5.1: "TO-220 type A package information"</i>.</p> <p>Minor text changes.</p>

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